



90VDC-110VDC Input

12V/0.3A Output

DNP FID1
 DNP FID2
 DNP FID3

PCB Number: PMP10739
 PCB Rev: A

PCB LOGO
 Texas Instruments



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Orderable: N/A	Designed for: Public Release	Mod. Date: 9/16/2015
TID #: PMP10739	Project Title: UCC28700 Flyback	
Number: PMP10739	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 1
Drawn By:	File: PMP10739_REVA_Sh1.SchDoc	Size: B
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